

SUNITEC ENTERPRISE CO.,LTD (BOM)

Proc	duct Type			Product Name BCK-X0		Page Number		Page 1 of 2		
	ile NO		Y-WD-08-01-074	Date	2007-12-10	Departme	nt	R&D	Version	V2.0
NO				Description and Value	Package	Qty	Ref	Manufacturer	Cost	
Integ	grate Circuit									
1 XC6204F		XC6204B332MR	3.3V LDO		SOT-25	1	U2			
			RCR3132-332SK	3.3V LDO		SOT-25				
2			TP4054	4.2V Charge	IC	SOT-25	1	U6		
3			BSS138	N-CHANNEI	SOT-23	1	Q1			
4			TPA2000D1PWR	Power Ampli	fier	TSSOP-16	1	U1		
			TPA2010D1YZFT	Power Ampli	fier	WCSP	1	U5		
5			BM153	Bluetooth CL	ASS 2 module	SOP60	1	U3		
6			ADG736	CMOS SPDT	SWITCH	MSOP10	1	U4		
			FSA4157AP6X	1Ω SPDT An	alog Switch	SC70	1	U9		
			NLAS4157DFT2G	1Ω SPDT Ana	alog Switch	SC70		U9		
7			24AA256	EEPROM	SOP8	1	U7			
Capa	acitor					•	•		•	•
			S2260JCXAM	Solid Tantalum	CAP1206	3	C15,C20, C21			
9			S1060JCXAM	Solid Tantalun	CAP1206	1	C37			
10				Ceramic Capa	CAP0603	4	C7,C8,C10,C23			
11				Ceramic Capacitor 224 10V +80/-20%		CAP0603	3	C1,C2,C11		
12				Ceramic Capacitor 104 10V +80/-20%		CAP0603	9	C13,C14,C16,C17, C18,C19,C22, C25,C26		
13				Ceramic Capa	CAP0603	1	C24			
14				Ceramic Capa	CAP0603	3	C6,C9,C27			
Indu	ictor									
15			R10	INDICTOR		L0603	7	L1,L2,L3,L4,L5,L6,L7		
Ris	istor									
16				Thick Film Ro	esistor 000R ±5%	RES0402	1	C5		
17				Thick Film Resistor 100R ±5%		RES0603	1	R8		
18			Thick Film Resistor 470R ±5%		RES0603	2	R13,R14			
19			Thick Film Resistor 2K ±5%		RES0603	1	R22			
20				Thick Film Ro	esistor 2.2K ±5%	RES0603	4	R5,R31,R33,R34		
21				Thick Film Ro	esistor 10K ±5%	RES0603	1	R15		
22				Thick Film Ro	esistor 36K ±5%	RES0603	2	R2,R3		
23				Thick Film R	esistor 47K ±5%	RES0603	6	R1,R17,R18,R21,R23, R24		
Pre	pared By			Approved By			App	roved By		
	. ,			11			11			



SUNITEC ENTERPRISE CO.,LTD (BOM)

Product Type				Product Name BFCK-X0		Page Number		Page 2 of 2			
File NO		FHY-WD-08-01-074		Date 2007-12-10		Department		R&D Vers		on V2.0	
NO	Part Number Manufacturers Part Number				Package	Qty	Ref	Manufacturer	Cost		
24			Thick Film Resistor 100K ±5%		RES0603	3	R4, R10,R35				
25			Thick Film Resistor 120K ±5%		RES0603	3	R9,R12,R27				
26			Thick Film Resistor 150K ±5%		RES0603	1	R26				
27				Thick Film Re	RES0603	3	R6,R20,R25				
Other	r Parts										
28			1N4148	SMD Diode		DIO1206	1	D2			
29			BLUE LED	SMD Red LEI	DIO0603	1	BLUE				
30			RED LED	SMD Red LEI		DIO0603	1	RED			
31			TS-3613_SMT	SMD Tact Swi	itch	6*3.5*2.5mm	3	SW1,SW2,SW3			
32			TS-3611_SMT	SMD Tact Swi	itch	7.8*4.2*3.5mm	1	SW4			
33				SMT USB MI	NI 5PIN		1	USB1			
34			Battery pedestal	Battery pede	estal		1	BAT1			
35			2PIN Female pedestal	2pin*1.5mm 9	0° DIP		1	SPK			
36			PCB BC330 V2.0	Bare pcb , d	louble sided 0.8mm thick FR4		1				
37			EM6027-38BC10&33-G	MIC -38dB±3	dB 1.5V 2.2K	Φ6*2.7mm	1	MIC1			
38			4R/2W	Speaker		Ф40mm	1				
39			Battery	NOKIA 6021	3.7V 600mAh	BL-5B	1				
40				Electron wir	`e	Ø1.0×20mm	1				
 											
╟─┼											
\parallel				1					+		
╟─┼											
 											
$\parallel - \parallel$			+						1	 	
$\Vdash \rightarrow$			+						+	 	
╠═┷	1.0					<u> </u>		1.D		<u> </u>	
Prep	ared By			Approved By			Approved By				

SUNITEC ENTERPRISE CO.,LTD

物料清单(BOM)

產品名称		BM153	產品类別 Bluetooth Module		頁 碼		第1頁,共1頁			
文件編号		F	HY-WD-08-01-048	發布日期 16.07.2008		發布部門		研發部	版次	V3.0
序号	元作	上編号 	供应商元件编号	元件规格描述		封裝	用量	元件位置	Manufacturer	Price
_	te circuit									
1	EI0-57E687BITB2 BC57E687B-ITB-E4		BC05 M	LFBGA	1	U1	CSR			
2	EI0-SST	39VF1602	SST39VF1601-90-4C-B3KE	Flash Me	48-ball FBGA	1	U2	SST		
	EI0-X29	LV160CB2	MX29LV160CBXBC-70G	Flash Memory(16MB,3V3)		48-ball FBGA		U2	MXIC	
	EI0-6D9	00BF10202	S29AL016D90BFI02	Flash Memory(16MB,3V3)		48-ball FBGA		U2	SPANSION	
RF						_				
3	EA0-BL	201205K20	BL2012-05K2450	S	2012	1	T1	ACX		
	EA0-CB	A47117140	CBA4711714002454K	S	MD Balun	2012		T1	YAGEO	
4	EA0-BF2	2012F2R40	BF2012-F2R4DAATKF	Ba	ndpass filter	2012	1	F1	ACX	
		L41117140	CFL4111714032454K	Ba	ndpass filter	2012		F1	YAGEO	
Capaci			T	·		1				
5		22P20GCC	C1005COG1H2R2CT	•	or(COG) 2p2 ±0.25pF 50V	0402	2	C15,C16	TDK	
6)206P8GC0	C1005COG1H6R8CT	Ceramic Capacito	0402	1	C10	TDK		
7)2045PGJC	C1005COG1H150DT	Ceramic Capaci	0402	2	C6,C17	TDK		
8		02018PGJ0	C1005COG1H180J	_	itor(COG) 18p ±5% 50V	0402	1	C11	TDK	
9		2010NGKX	C1005X7R1C103ZT		tor(X7R) 10n ±10% 50V	0402	4	C4,C5,C8,C14	TDK	
10	ECS-040	2022NDK0	C1005X7R1C223ZT	•	tor(X7R) 22n ±10% 50V	0402	1	C12	TDK	
11	ECS-040	2047NGK0	C1005X7R1C473ZT	Ceramic Capaci	tor(X7R) 47n ±10% 50V	0402	1	C13	TDK	
12	ECS-060	32U20AZ0	C1608Y5V1A225Z	Ceramic Capacitor	C(X5R) 2u2 +80,-20% 6.3V	0603	4	C2,7,C9,C18	TDK	
13	ECS-080	05010UBZ0	C2012X5R1A106Z	Ceramic Capacitor	C(X5R) 10u +80,-20% 6.3V	0805	1	C3	TDK	
Resisto				T		1			•	
14	ERS-040	022R200J0	MCR01MZSJ2R2E	Thick Film	Resistor 2R2 ±5%	0402	3	R1,R2,R3	ROHM	
Inducto			_	T						
15	ELS-080	06022U0K0	LQH2MCN220K02L	Thick Film Inductor 22u ±10%		0806	1	L1	Murata	
16	ELS-040)203N30F0	LQP15MN3N3B02	Thick Film Inductor 3.3n ±0.1		0402	2	L2, L3	Murata	
17	ELS-040	02022N0J0	LQP15MN22NG02	Thick Film	0402	1	L4	Murata		
Crystal			Γ	T		T				
18 DCD	EJ0-3D0)2D526000		SMD Crystal 26MHz ±10ppm		3*2.5	1	Y1	Toyocom	
PCB 19	EPB-BC0	05MM10000	PB-BC05MM-ExtM-V1.0	FR4 四層板 鍍金 REV:1.0		21*13.5*0.6	1			
带	〕 定		<u> </u>	審核			核	准	1	
[, ~							. р		